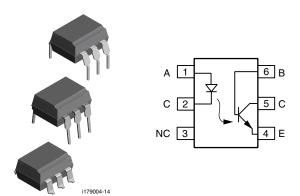


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Vishay Semiconductors

Optocoupler, Phototransistor Output, with Base Connection



DESCRIPTION

This datasheet presents five families of Vishay industry standard single channel phototransistor couplers. These families include the 4N35, 4N36, 4N37, 4N38 couplers.

Each optocoupler consists of gallium arsenide infrared LED and a silicon NPN phototransistor.

These couplers are Underwriters Laboratories (UL) listed to comply with a $5000 \, V_{RMS}$ isolation test voltage.

This isolation performance is accomplished through Vishay double molding isolation manufacturing process. Comliance to DIN EN 60747-5-5 partial discharge isolation specification is available for these families by ordering option 1.

These isolation processes and the Vishay ISO9001 quality program results in the highest isolation performance available for a commecial plastic phototransistor optocoupler.

The devices are available in lead formed configuration suitable for surface mounting and are available either on tape and reel, or in standard tube shipping containers.

Note

 For additional design information see application note 45 normalized curves

FEATURES

- Isolation test voltage 5000 V_{RMS}
- · Interfaces with common logic families
- Input-output coupling capacitance < 0.5 pF
- Industry standard dual-in-line 6 pin package
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

Pb-free



RoHS

APPLICATIONS

- · AC mains detection
- · Reed relay driving
- Switch mode power supply feedback
- Telephone ring detection
- · Logic ground isolation
- · Logic coupling with high frequency noise rejection

AGENCY APPROVALS

- UL file no. E52744 (pending)
- cUL tested to CSA 22.2 bulletin 5A
- DIN EN 60747-5-2 (VDE 0884)/DIN EN 60747-5-5 (pending), available with option 1
- BSI: EN 60065, EN 60950-1
- FIMKO
- CQC

normalized curves					
ORDERING INFORMATIO	N				
4 N 3 PART NUMBER	x - X	0 # [AND C	DIP-6 Option 6 10.16 mm Option 7 Option 9 8 mm typ.	
AGENCY CERTIFIED/PACKAGE		10 mA	R (%)		
AGENOT GENTINED/T AGNAGE		20 mA			
UL, cUL, BSI, FIMKO		≥ 100		≥ 20	
DIP-6	4N35-X000	4N36-X000	4N37-X000	4N38	
DIP-6, 400 mil, option 6	4N35-X006	-	4N37-X006	-	
SMD-6, option 7	4N35-X007T ⁽¹⁾	4N36-X007	4N37-X007	4N38-X007T ⁽¹⁾	
SMD-6, option 9	4N35-X009T (1)	4N36-X009T (1)	4N37-X009	4N38-X009T	
VDE, UL, cUL, BSI, FIMKO	≥100 ≥20				
			4N37-X001		
DIP-6	4N35-X001	-	4N37-X001	=	
DIP-6 DIP-6, 400 mil, option 6	4N35-X001 4N35-X016	-	41137-2001	-	
			41N37-X001 - -	-	

Notes

SMD-6, option 9

Rev. 1.8, 16-Jan-12

• Additional options may be possible, please contact sales office.

4N35-X019T

(1) Also available in tubes; do not put T on end.



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
INPUT							
Reverse voltage		V_{R}	6	V			
Forward current		I _F	60	mA			
Surge current	t ≤ 10 μs	I _{FSM}	2.5	Α			
Power dissipation		P _{diss}	70	mW			
OUTPUT							
Collector emitter breakdown voltage		V _{CEO}	70	V			
Emitter base breakdown voltage		V _{EBO}	7	V			
Collector current		I _C	50	mA			
Collector peak current	$t_p/T = 0.5, t_p \le 10 \text{ ms}$	I _{CM}	100	mA			
Output power dissipation		P _{diss}	150	mW			
COUPLER							
Isolation test voltage	t = 1 s	V_{ISO}	5000	V _{RMS}			
Creepage distance			≥ 7	mm			
Clearance distance			≥7	mm			
Isolation thickness between emitter and detector			≥ 0.4	mm			
Comparative tracking index	DIN IEC 112/VDE 0303, part 1		≥ 175				
la clation vaciation as	V _{IO} = 500 V, T _{amb} = 25 °C	R _{IO}	≥ 10 ¹²	Ω			
Isolation resistance	V _{IO} = 500 V, T _{amb} = 100 °C	R _{IO}	≥ 10 ¹¹	Ω			
Storage temperature		T _{stg}	- 55 to + 150	°C			
Operating temperature		T _{amb}	- 55 to + 100	°C			
Soldering temperature (1)	2 mm from case, ≤ 10 s	T _{sld}	260	°C			

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
 implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
 maximum ratings for extended periods of the time can adversely affect reliability.
- (1) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering condditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
INPUT								
Forward voltage (1)	I _F = 10 mA		V_{F}		1.2	1.5	V	
	$I_F = 10 \text{ mA}, T_{amb} = -55 \text{ °C}$		V_{F}	0.9	1.3	1.7	V	
Reverse current (1)	V _R = 6 V		I _R		0.1	10	μΑ	
Capacitance	V _R = 0 V, f = 1 MHz		Co		25		pF	
OUTPUT								
		4N35	BV _{CEO}	30			V	
Collector emitter breakdown	I _C = 1 mA	4N36	BV _{CEO}	30			V	
voltage (1)		4N37	BV _{CEO}	30			V	
		4N38	BV _{CEO}	80			V	
Emitter collector breakdown voltage (1)	I _E = 100 μA		BV _{ECO}	7			V	
Collector base breakdown		4N35	BV _{CBO}	70			V	
	1 100 1 1 4	4N36	BV _{CBO}	70			V	
voltage ⁽¹⁾	$I_C = 100 \mu A, I_B = 1 \mu A$	4N37	BV _{CBO}	70			V	
		4N38	BV _{CBO}	80			V	

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
OUTPUT								
	$V_{CE} = 10 \text{ V}, I_F = 0$	4N35	I _{CEO}		5	50	nA	
		4N36	I _{CEO}		5	50	nA	
	$V_{CE} = 10 \text{ V}, I_F = 0$	4N37	I _{CEO}		5	50	nA	
	$V_{CE} = 60 \text{ V}, I_F = 0$	4N38	I _{CEO}			50	nA	
Collector emitter leakage current (1)	V _{CE} = 30 V, I _F = 0, T _{amb} = 100 °C	4N35	I _{CEO}			500	μΑ	
		4N36	I _{CEO}			500	μA	
		4N37	I _{CEO}			500	μΑ	
	$V_{CE} = 60 \text{ V}, I_F = 0,$ $T_{amb} = 100 ^{\circ}\text{C}$	4N38	I _{CEO}		6		μΑ	
Collector emitter capacitance	$V_{CE} = 0$		C _{CE}		6		pF	
coupler								
Resistance, input output (1)	$V_{1O} = 500 \text{ V}$		R _{IO}	10 ¹¹			Ω	
Capacitance, input output	f = 1 MHz		C _{IO}	•	0.5		pF	

Notes

⁽¹⁾ Indicates JEDEC registered value.

CURRENT TRANSFER RATIO (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
I _C /I _F (1)		4N35	CTR _{DC}	100			%	
	$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$	4N36	CTR _{DC}	100			%	
		4N37	CTR _{DC}	100			%	
	$V_{CE} = 10 \text{ V}, I_F = 20 \text{ mA}$	4N38	CTR _{DC}	20			%	
		4N35	CTR _{DC}	40	50		%	
	V _{CE} = 10 V, I _F = 10 mA, T _A = -55 °C to + 100 °C	4N36	CTR _{DC}	40	50		%	
		4N37	CTR _{DC}	40	50		%	
		4N38	CTR _{DC}		30		%	

Note

⁽¹⁾ Indicates JEDEC registered values.

SWITCHING CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION SYMBOL MIN. TYP. MAX. U				UNIT		
Turn-on time (1)	$V_{CC} = 5 \text{ V}, I_{C} = 2 \text{ mA}, R_{L} = 100 \Omega$	t _{on}		10		μs	
Turn-off time (1)	$V_{CC} = 5 \text{ V}, I_{C} = 2 \text{ mA}, R_{L} = 100 \Omega$	t _{off}		10		μs	

Note

(1) Indicates JEDEC registered values.

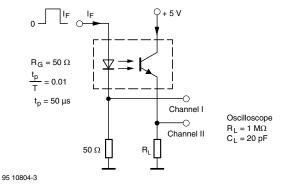


Fig. 1 - Test Circuit, Non-Saturated Operation

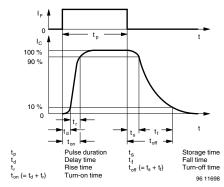


Fig. 2 - Switching Times

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

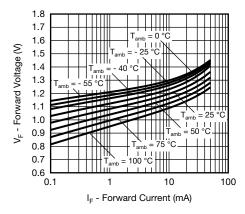


Fig. 3 - Forward Voltage vs. Forward Current

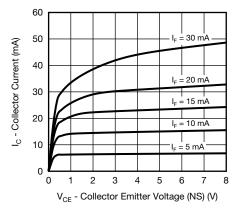


Fig. 4 - Collector Current vs. Collector Emitter Voltage (NS)

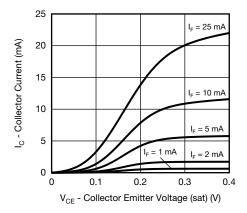


Fig. 5 - Collector Current vs. Collector Emitter Voltage (sat)

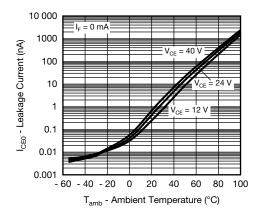


Fig. 6 - Leakage Current vs. Ambient Temperature

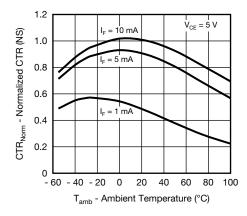


Fig. 7 - Normalized CTR (NS) vs. Ambient Temperature

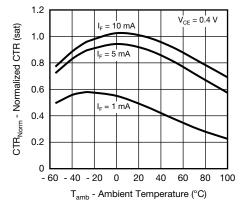


Fig. 8 - Normalized CTR (sat) vs. Ambient Temperature

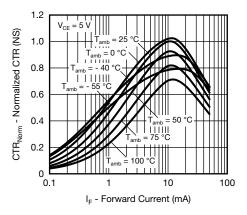


Fig. 9 - Normalized CTR (NS) vs. Forward Current

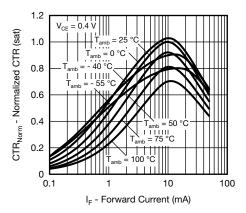


Fig. 10 - Normalized CTR (sat) vs. Forward Current

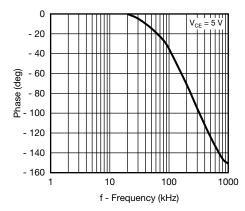


Fig. 11 - CTR Frequency vs. Phase Angle

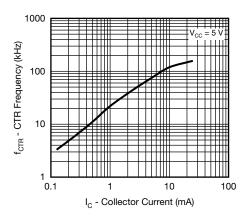


Fig. 12 - CTR Frequency vs. Collector Current

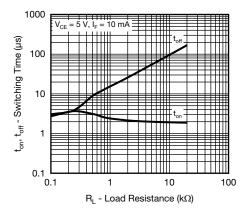
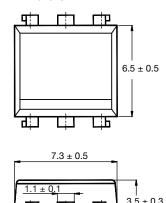
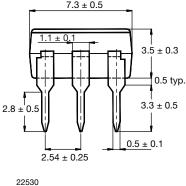
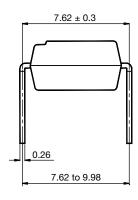


Fig. 13 - Switching Time vs. Load Resistance

PACKAGE DIMENSIONS in millimeters



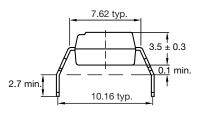


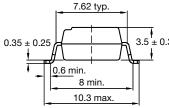


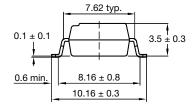
Option 6

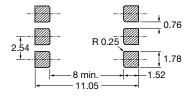
Option 7

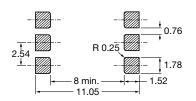
Option 9





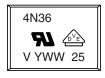






PACKAGE MARKING

20802-34



Notes

- · VDE logo is only marked on option 1 parts. Option information is not marked on the part.
- Tape and reel suffix (T) is not part of the package marking.



Legal Disclaimer Notice

Vishay

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